





## Katherine: Ethernet Embedded Readout Interface for Timepix3



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## Outline

### Timepix3 – Fundamental Description

- Motivation
- Description of readout device
  - Fundamental Features
  - Interfaces
  - Communication
  - Software support
- Demonstration of usage
- Summary

## Timepix3 – Fundamental Description

- Hybrid pixel detector
- Resolution 256x256 pixels; pixel pitch 55µm
- Developed within Medipix3 Collaboration, CERN
- Designed in 130nm CMOS technology



Measuring ToT (energy) and ToA (time-stamping) simultaneously

#### ToA measurement:

- Coarse ToA clock = 40MHz => 25 ns
- Fine ToA clock = 640MHz (ring oscillator) => 1.56ns
- Global time stamp range 14 bits => 409.6 µs

#### Readout modes:

- Frame-based mode with zero-suppressed (max ~1300 fps)
- Data-driven mode (~40Mhits/s); dead time per pixel min. 475ns
- Acq. modes: ToA & ToT, Only ToA, Event Count & Integral ToT
- Output data: up to 8 serial lines @ 640MHz => max. data rate = 5.12 Gbps

## **Motivation**



- Long distances
- Independent device
- Cons:
  - Limited hit rate
  - Ethernet ports



## Katherine – Features

- Embedded computer + interface for one Timepix3 (CERN chipboard)
- Optimized for long distance between sensor and readout
- Source of high voltage for bias both polarities (±300V)
- Gigabit Ethernet Interface => max. 15Mhits/s
- Long-distance access (up to 100m)
- Dimension: roughly 100x80x28





## Katherine – Interfaces

- VHDCI connector
  - Direct connection of chipboard or VHDCI extending cable
- Power supply DC 5V
- Bias voltage LEMO connector voltage range ±300V
- Status LED diodes (programmable by user)
- GPIO port purpose of signals defined by control SW
  - 1x single-ended input (possible to use as external clock)
  - 1x single-ended BiDir signal
  - 1x LVDS input, 1x LVDS output





## Katherine – Communication

- Communication with sensor:
  - Two "fast" lines (2x 640Mbs)
    - Embedded clock
    - Direct connection with chipboard
    - Shorter distance via VHDCI cable (max. approx. 3.5m)
    - Hit rates: up to 20Mhit/s (but limited by Gigabit Ethernet bottle-neck)
  - Four "slow" lines (4x 160Mbs, 4x 80Mbs or 4x 40Mbs)
    - Longer distance between readout and chipboard
    - Verified: 10m VHDCI cable at 4x160Mbs rate
    - Hit rates: up to 10Mhit/s
  - Automic setting of maximal speed according to used cable during power-up sequence
- Communication with computer/server:
  - Peer-to-peer communication with computer (based on UDP datagrams; TCP/IP in development)
    - 36 control/status commands
  - Automatic/independent sending data to server (via SSH connection)

## Katherine – Communication

- How to connect sensor...
  - Directly (CERN chipboard)
  - Extending VHDCI cable



- Active or passive ethernet cabling extenders
  - Up to 100m distance between sensor and readout
  - 20m => no decreasing in speed
  - Radiation hardness solution
  - New rad. hard. chipboard







## Katherine – Other Features

- Automatic correction of corrupted ToA timing
  - Bug in Timepix3 ASIC chip
  - Column 192 and its neighbourhood
  - ToA counter shifted about 25ns
  - Using testpulses during power-up sequence
  - "On-line" correction directly in readout device
  - Choice of user
- ToA overflow in data-driven mode
  - Coarse ToA counter overflow period = 409.6µs
  - The device adds 32 extra bits for time-stamping
  - Overall 50-bit (32 extra, 14 ToA, 4 fToa) time-stamping => overflow period is ~20 days
- All data from Timepix3 are decoded from LFSR and Gray to binary code in the device
- Enough computing power for user purpose:
  - Approximately 8000 ALMs in FPGA free to use
  - Dual-core ARM Cortex-A9 processor
  - 1GB DDR3 RAM



## Katherine – Software support

- Completely new software tool was developed
- No support of Pixelaman or Pixet SW at this moment
- Basic functionality is ensured (equalization, THL scans, internal DAC scans, data taking, temperature monitoring, internal test pulses, trigger settings etc.)
- Supporting more devices connected in LAN

## Katherine – Software support

💀 ---BurdaMan--- Chip ID: H6-W0005 | IP address of readout: 192.168.1.31



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## Katherine – Internal DACs – Settings and Scan



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## Chip Equalization and Threshold Scan (Calibration)



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## **Demonstration of Energy Calibration**



## Katherine – GPIO Signals and Triggering



## Measurement at ATLAS Cavern - Device

- Long distance between sensor and readout (~ 80m, verified also for 100m)
- Using ethernet cabling extenders + rad. hard. chipboard
- Maximal hitrate ~5 Mhits/s (after minor modification up to 10 Mhits/s)



## Measurement at ATLAS Cavern – Demonstration

- 10 s "frame" in data-driven mode
- ▶ Si500µm



## Measurement at SPS, CERN – 120GeV Pions

- 5 ms "frame" in data-driven mode
- ▶ Si500µm



## Measurement at SPS, CERN – Particle Telescope

- Two Timepix3 detectors as particle telescope
- Analysis of Concurrent Tracks (time-differences between layer1 and layer2)



- Resolution  $\sigma = 1.548$
- Offset due to 80 cm particle motion (2.67 ns)
- Offset of measuring chain ~1.8ns



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## Measurement at SPS, CERN – 3D Trajectory Reconstruction



Bergmann, B., Pichotka, M., Pospisil, S. et al. Eur. Phys. J. C (2017) 77: 421. doi:10.1140/epjc/s10052-017-4993-4

## Summary

- Gigabit Ethernet interface
- Main drawback: 15Mhits/s
- Independent sending data to server or NAS (usable with low rate ~kHits/s)
- Ecosystem:
  - Software tool for detector control and data taking (Windows platform)
  - Simple SW tool for data taking (Windows, Linux, Mac)
  - Synchronization board and TDC device for interconnection of more devices
  - Radiation hardened chipboard
  - Extenders for long distances
  - Web-based visualization tool (J. Vycpalek from IEAP in Prague)
- Readouts are available (several pieces in stock) for interested people





# Thank you for your attention

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